

Customer View Model

3D_IGS.ZIP

English

Customer View Model

3D_STP.ZIP

English

Product Specifications

Product Specification

DDR S.O.DIMM Socket 200 Positions

PDF

English

FEATURES



Please review product documents or [contact us](#) for the latest agency approval information.

Please Note: Use the Product Drawing for all design activity.

Product Type Features

- DRAM Type** Double Data Rate (DDR)
- Profile** Standard
- Row-to-Row Spacing** 6.2 mm [.244 in]
- Connector & Contact Terminates To** Printed Circuit Board
- Product Type** Socket

Configuration Features

- Module Orientation** Right Angle
- Number of Positions** 200
- Number of Rows** 2
- Keying** Standard
- Number of Keys** 1
- Center Key** None
- Number of Bays** 2

Electrical Characteristics

- DRAM Voltage (V)** 1.8

Signal Characteristics

- SGRAM Voltage (V)** 1.8

Body Features

- Ejector Type** Locking
- Module Key Type** SGRAM
- Latch Material** Stainless Steel
- Ejector Location** Both Ends

Contact Features

Solder Tail Contact Plating Material Gold Flash
Contact Mating Area Plating Material Gold Flash
Contact Base Material Copper Alloy
Socket Type Memory Card
Socket Style SO DIMM

Termination Features

Insertion Style Cam-In

Mechanical Attachment

PCB Mounting Style Surface Mount
PCB Mount Retention With
PCB Mount Retention Type Solder Peg

Housing Features

Centerline (Pitch) .6 mm [.024 in]
Housing Material High Temperature Thermoplastic
Housing Color Black

Dimensions

Stack Height 8 mm [.315 in]

Industry Standards

UL Flammability Rating UL 94V-0

Packaging Features

Packaging Method Semi-Hard Tray Assembly
Packaging Quantity 20

PRODUCT COMPLIANCE



Statement of Compliance

Statement of Compliance
PDF